

Cautions for soldering

1. Recommended solder

Flux cored solder (Lead-free: Sn-3Aq-0.5Cu)

Micro coaxial cable - - - 0.15 mm dia, Length 10.5 mm

· · · 0.1 mm dia, Length 10.5 mm

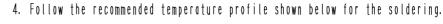
If you consider using additional flux, please pay enough attention not to have flux wicking to the contact area. Flux wicking to the contact area will cause contact failure.

2. Setting the cable

Set the conductors as each conductor is placed at the center of the cantact.

In case of micro coaxial cable, set it as the metal bar fits in the guide on the connector.

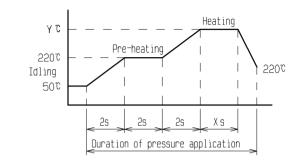
In case of FFC, set it as the grounding plate side faces to the connector.



The optimum condition could vary depending on various factors including type of cable and its length, solder type. Therefore refer to the recommended temperature profile and optimize the condition if necessary.

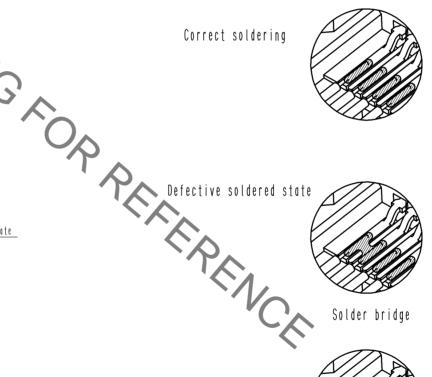
Solder tip pressurization	13 ~ 17 N
------------------------------	-----------

heating		Micro coaxial cable	FFC	
	Temperature (Y)	275± 5 ℃	265± 5 ℃	
	Duration (X)	2± 0.5 sec	2.5± 0.5 sec	

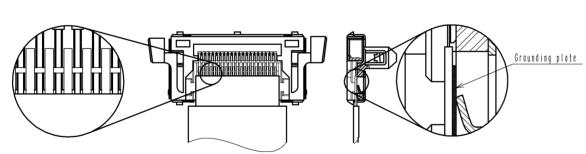


5. After soldering, check that no defect is found at soldered area. Examples of correct soldered and defective soldered state are shown below.

Correct soldering



Conductors are placed at the center of the contact, and whole area is equally wetted.

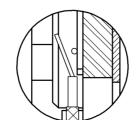


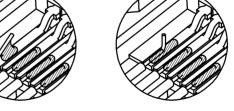


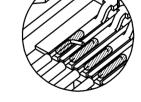
- · Transformation of conductor
- · Misalignment of conductor to the terminals in pitch direction
- Excessive floating of conductor

The above could cause soldering failure and/or solder bridge.

Transformation of conductor Misalignment in pitch direction Floating







Solder ball dispersion

Conductor sticking out The conductor approaches to the adjacent contact

*Note: The figures shown in this page are solely for the instruction purpose. Therefore the appearance could differ from the actual connectors. Refer to the drawing for the actual design (sheet 1).

Solder shortage

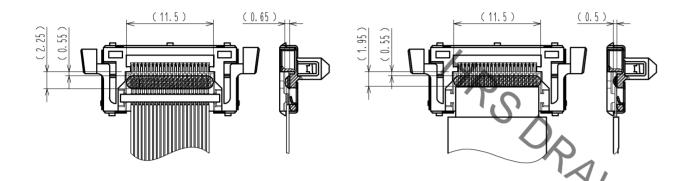
	HS.	DRAWING NO.	EDC3-158269-01
		PART NO.	FX16-21P-0.5SDL
		CODE NO.	CL575-3321-4-00 \ \(\triangle \)
		7	0

Floating

FORM HC0011-5-8

Cautions for potting process

- 1. Protect the soldered area by UV cured resin or any equivalent (referred to as 'potting' hereafter). In order to prevent insulating failure caused by metal adhering, cable breakage during cabling and other troubles.
- 2. Apply 3033 manufactured by THREEBOND CO., LTD. or any equivalent product for potting. Follow the instruction of potting manufacture's for the condition of UV exposure.
- 3. Refer to the following conditions for the potting area.



4. Use extreme care for the handling after soldering to the end of potting process not to apply stress to the cable, otherwise, cable could be broken.

Exercise extreme caution during the process so that no resin flows or adheres to the contact area.

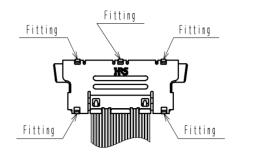
Cautions for cover shell assembly

1. Attach a cover shell separately provided after the cable assembly process.

For micro coaxial cabla : FX16-21P-GNDL
For FFC : FX16-21P-GNDL(A)

2. Place the cover shell onto the connector horizontally and pinch two components from top and bottom with fingers.

3. Check the five fitting points after assembly and make sure that they are all correctly fitted together.



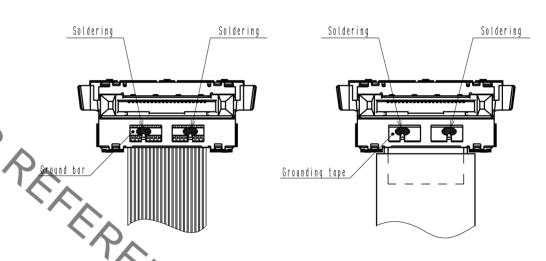
How to check fitting points (Cut section of fitting points) Ground plate hooks the protrusion of connector housing Ground plate does not hoo the protrusion of connect



Ground plate does not hook the protrusion of connector housing

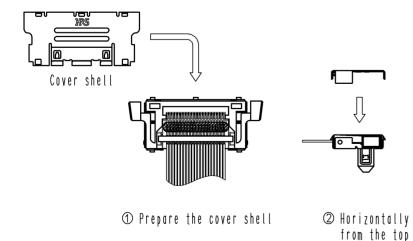
Soldering to ground plate

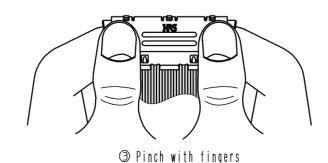
1. Solder down the metal bar of the cable and ground plate after the assembly of ground plate in order to enhance the grounding performance and robustness against cable stroke to up and down direction.



2. Excess solder and/or excess heating could cause cable and connector deformation and/or melt.

Cable assembly process is completed.





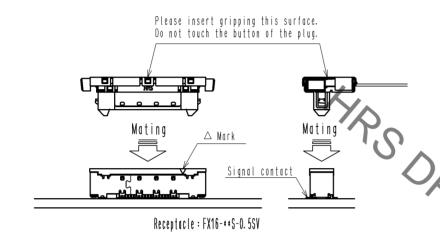
*Note: The figures shown in this page are solely for the instruction purpose. Therefore the appearance could differ from the actual connectors. Refer to the drawing for the actual design (sheet 1).

		DRAWING NO.	EDC3-158269-01	
l	H1 5	PART NO.	FX16-21P-0.5SDL	
•		CODE NO.	CL575-3321-4-00	5/6
		7	0	

Handling instructions

1. Insertion to on-board connector

The connector mating is keyed. Align the marks as shown in the figure for mating. Insert the connector completely until they are locked at both ends.



The connectors have a reverse-insertion prevention structure, however, the connectors may be damaged when inserted reversely with the force of 25 N or more. Avoid a forceful insertion, and make sure to confirm that the connectors are aligned with the marks before the mating operation.

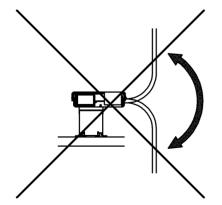
2. After mating

FORM HC0011-5-8

Carefully wire cables, so that excessive force will not be applied to the mated connectors. Pulling the cable with the force of 20 N or more may damage the connectors. It may also cause cable breakage. Take a caution to avoid pulling the cables.

Repetitive cable strokes could also cause cable breakage as well. Do not use the connector under the environment of repetitive cable strokes.

Take enough bend radius and/or distance from the connector for the cable not to apply stress to the connector base when the application requires cable bend back.



Take long distance from the connector body

Take large radius

Repetitive cable strokes

Application of cable bend back

*Note: The connectors shown in this page are drawn for the instruction purpose, therefore, the appearance differs from the actual connectors.

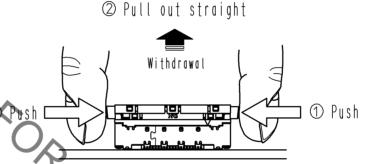
Please confirm the connector configuration on the connector drawing (SHEET 1).

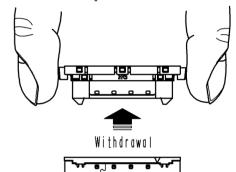
3. Withdrawal from on-board connector

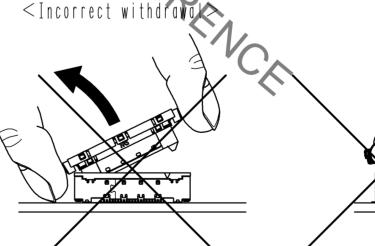
The connectors are locked while they are mated. In order to unmate the connectors, pull out straight, with the button pushed to release the lock. At this time, do not pull the cable. Also, avoid the withdrawal in angle, which may damage the connectors.

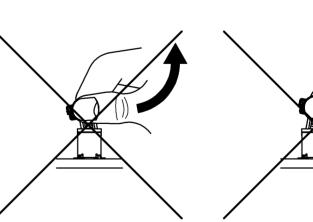
<Correct withdrawal>

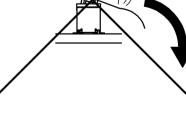
③ Pull out straight, with the button pushed.











PART NO. FX16-21P-0.5SDL CODE CL575-3321-4-00

4 5



OOO «ЛайфЭлектроникс" "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 P/C 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 3010181090000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный) Email: org@lifeelectronics.ru